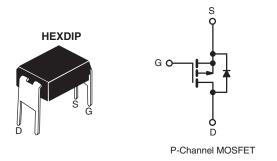


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	- 100				
$R_{DS(on)}\left(\Omega\right)$	V _{GS} = - 10 V	0.60			
Q _g (Max.) (nC)	18				
Q _{gs} (nC)	3.0				
Q _{gd} (nC)	9.0				
Configuration	Single				



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- P-Channel
- 175 °C Operating Temperature
- · Fast Switching
- Lead (Pb)-free Available

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertiable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HEXDIP
Lead (Pb)-free	IRFD9120PbF
Lead (PD)-liee	SiHFD9120-E3
SnPb	IRFD9120
SIIFD	SiHFD9120

ABSOLUTE MAXIMUM RATINGS T _C = 25 °C, unless otherwise noted						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	- 100	V	
Gate-Source Voltage			V_{GS}	± 20	\ \ \ \ \ \	
Continuous Drain Current	V at 10.V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	- I _D	- 1.0		
	V _{GS} at - 10 V	T _C = 100 °C		- 0.70	Α	
Pulsed Drain Current ^a			I _{DM}	- 8.0	1	
Linear Derating Factor				0.0083	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	140	mJ	
Repetitive Avalanche Current ^a			I _{AR}	- 1.0	Α	
Repetitive Avalanche Energy ^a			E _{AR}	0.13	mJ	
Maximum Power Dissipation	T _C = 25 °C		P_{D}	1.3	W	
Peak Diode Recovery dV/dt ^c			dV/dt	- 5.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 52 mH, R_G = 25 Ω , I_{AS} = 2.0 A (see fig. 12).
- c. $I_{SD} \le$ 6.8 A, $dI/dt \le$ 110 A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le$ 175 °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRFD9120, SiHFD9120

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R_{thJA}	-	120	°C/W	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	V _{GS} = 0 V, I _D = - 250 μA			-	٧
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = - 1 mA	-	- 0.10	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	: V _{GS} , I _D = - 250 μA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V		-	± 100	nA
Zone Onto Valle on Busin Oursell		V _{DS} = - 100 V, V _{GS} = 0 V		-	-	- 100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 80 \	V, V _{GS} = 0 V, T _J = 150 °C	-	-	- 500	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 0.6 A ^b	-	-	0.60	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	V _{DS} = - 50 V, I _D = - 0.60 A ^b		-	-	S
Dynamic		•					
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V}$ $V_{DS} = -25 \text{ V}$ $f = 1.0 \text{ MHz, see fig. 5}$		-	390	-	pF
Output Capacitance	C _{oss}			-	170	-	
Reverse Transfer Capacitance	C _{rss}			-	45	-	
Total Gate Charge	Qg		I _D = - 6.8 A, V _{DS} = - 80 V see fig. 6 and 13 ^b	-	-	18	nC
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V		-	-	3.0	
Gate-Drain Charge	Q_{gd}]	goo ngi o ana io	-	-	9.0	
Turn-On Delay Time	t _{d(on)}			-	9.6	-	- ns
Rise Time	t _r	V _{DD} =	V _{DD} = - 50 V, I _D = - 6.8 A		29	-	
Turn-Off Delay Time	$t_{d(off)}$	$R_{G} = 18 \Omega$, $R_{D} = 7.1 \Omega$, see fig. 10^{b}		-	21	-	
Fall Time	t _f			-	25	-	
Internal Drain Inductance	L_D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	nH
Internal Source Inductance	L _S			-	6.0	-	1111
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 1.0	Α
Pulsed Diode Forward Current ^a	I _{SM}			-	-	- 8.0	
Body Diode Voltage	V _{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = -1.0 \text{A}, V_{GS} = 0 \text{V}^{\text{b}}$		-	-	- 6.3	٧
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = -6.8 \text{A}, \text{dI/dt} = 100 \text{A/}\mu\text{s}^b$		-	98	200	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.33	0.66	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_I				L _D)	

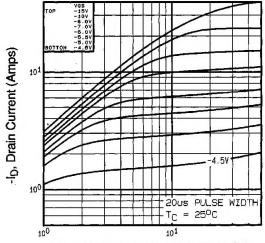
Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



-V_{DS}, Drain-to-Source Voltage (volts)

Fig. 1 - Typical Output Characteristics, T_C = 25 °C

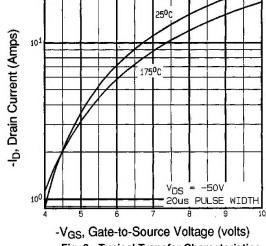


Fig. 3 - Typical Transfer Characteristics

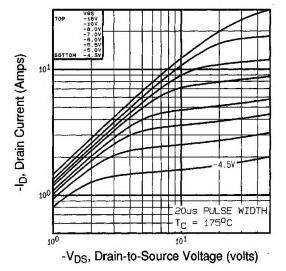


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

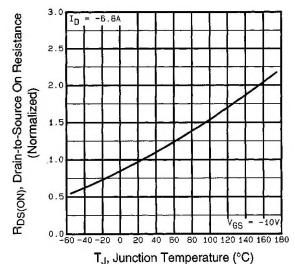


Fig. 4 - Normalized On-Resistance vs. Temperature

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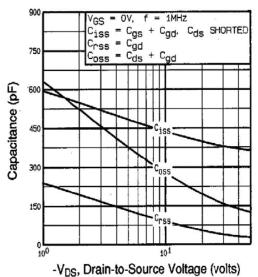


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

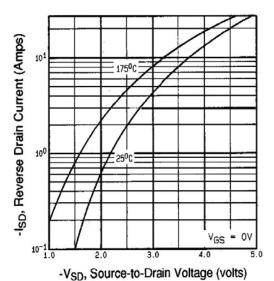


Fig. 7 - Typical Source-Drain Diode Forward Voltage

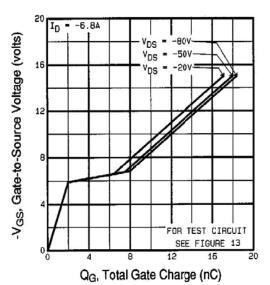


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

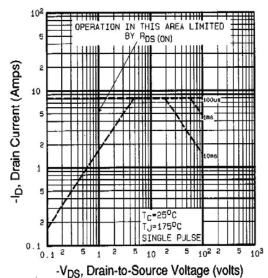


Fig. 8 - Maximum Safe Operating Area





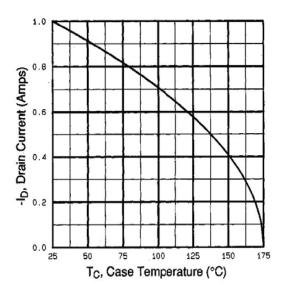


Fig. 9 - Maximum Drain Current vs. Case Temperature

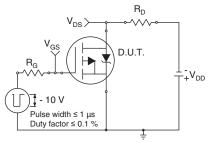


Fig. 10a - Switching Time Test Circuit

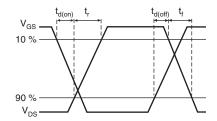


Fig. 10b - Switching Time Waveforms

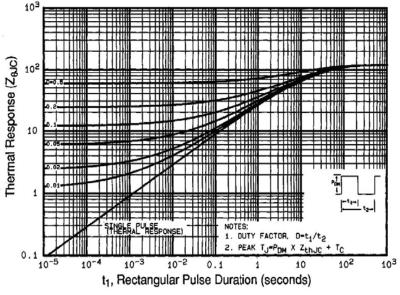


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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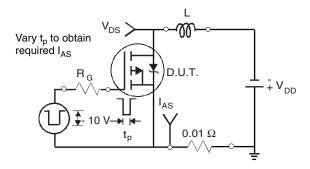


Fig. 12a - Unclamped Inductive Test Circuit

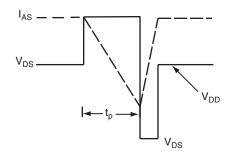


Fig. 12b - Unclamped Inductive Waveforms

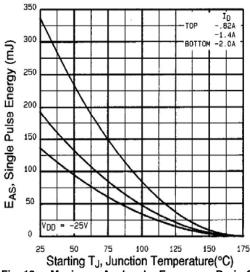


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

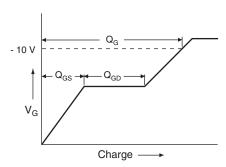


Fig. 13a - Basic Gate Charge Waveform

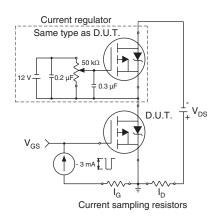
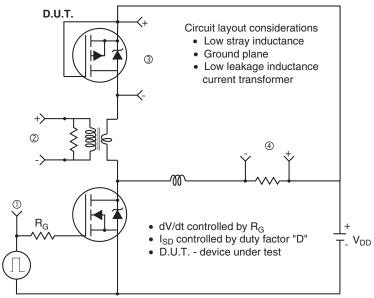


Fig. 13b - Gate Charge Test Circuit

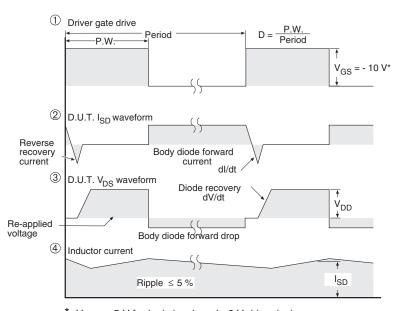




Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver



 * V_{GS} = -5 V for logic level and -3 V drive devices

Fig. 14 - For P-Channel

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